

RKP200KN

Silicon Epitaxial Planar Pin Diode for Antenna Switching

REJ03G1302-0200

Rev.2.00

Feb 14, 2006

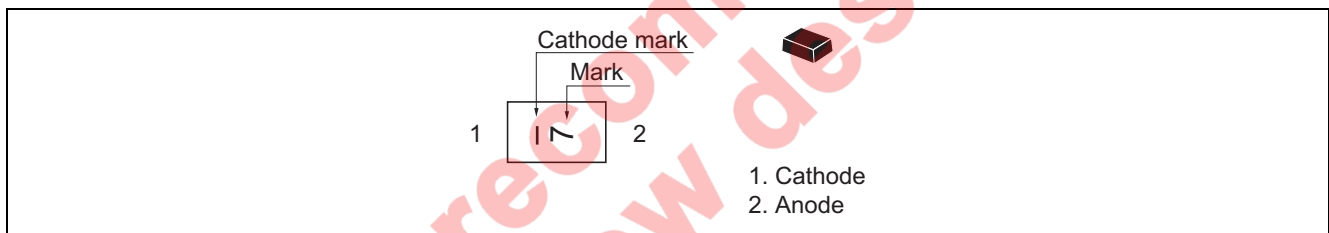
Features

- An optimal solution for antenna switching in mobile phones.
- Low capacitance. ($C = 0.35$ pF max)
- Low forward resistance. ($r_f = 1.3 \Omega$ max)
- Ultra small leadless Package (0805type; the use of an undersurface electrode structure) for use in compact and products.

Ordering Information

Type No.	Laser Mark	Package Name	Package Code
RKP200KN	7	MP8	PXSN0002ZA-A

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	30	V
Forward current	I_F	100	mA
Power dissipation	P_d	100	mW
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 to +125	°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Forward voltage	V_F	—	—	1.0	V	$I_F = 10 \text{ mA}$
Reverse current	I_R	—	—	100	nA	$V_R = 30 \text{ V}$
Capacitance	C	—	—	0.35	pF	$V_R = 1 \text{ V}, f = 1 \text{ MHz}$
Forward resistance	r_f	—	—	1.3	Ω	$I_F = 10 \text{ mA}, f = 100 \text{ MHz}$
ESD-Capability *1	—	100	—	—	V	$C = 200 \text{ pF}, R = 0 \Omega$, Both forward and reverse direction 1 pulse.

Notes: 1. Failure criterion ; $I_R > 100 \text{ nA}$ at $V_R = 30 \text{ V}$

2. Please do not use the soldering iron due to avoid high stress to the MP8 package.

Not recommended for new designs

Main Characteristic

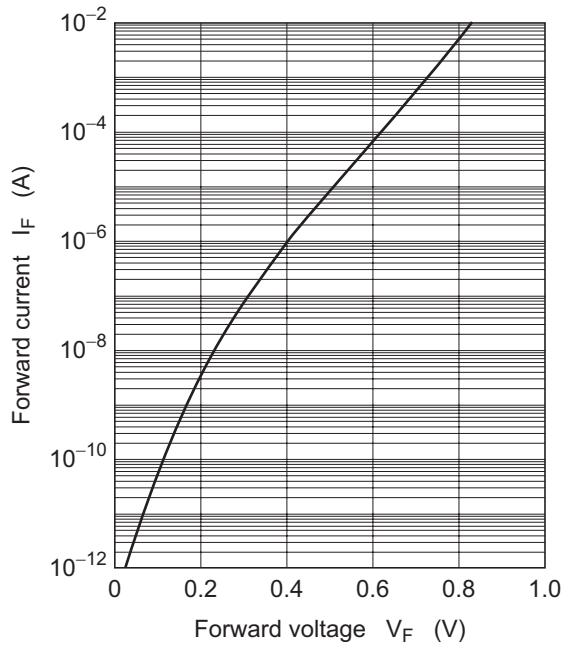


Fig.1 Forward current vs. Forward voltage

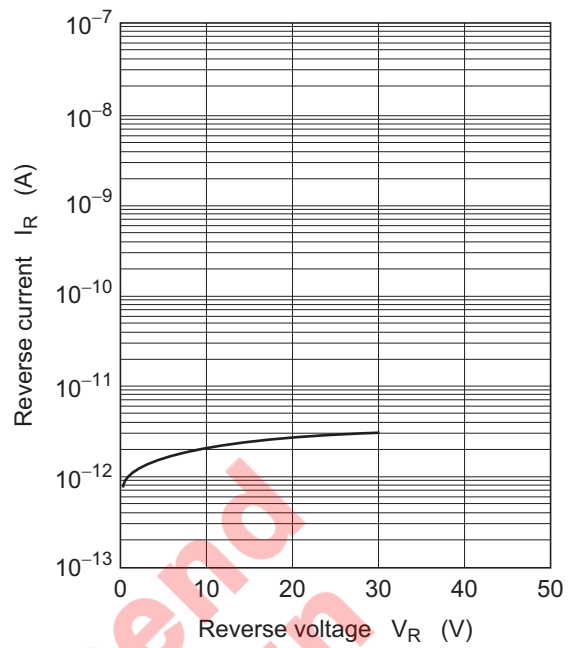


Fig.2 Reverse current vs. Reverse voltage

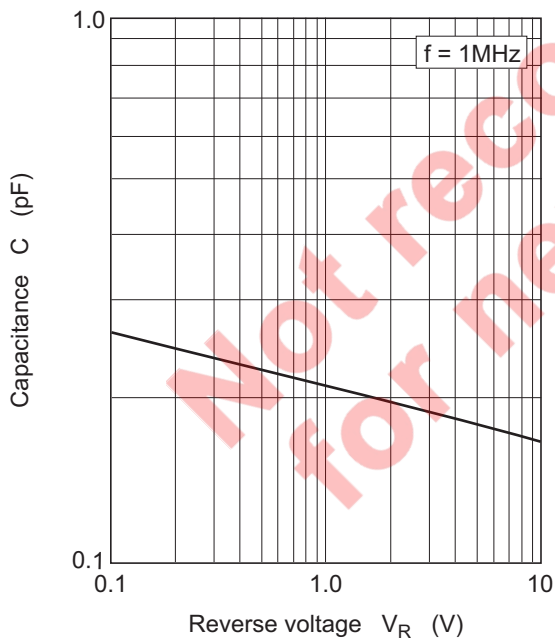


Fig.3 Capacitance vs. Reverse voltage

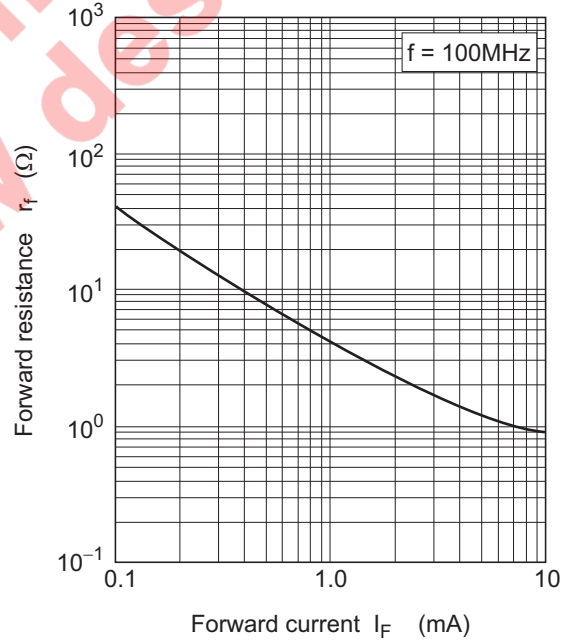
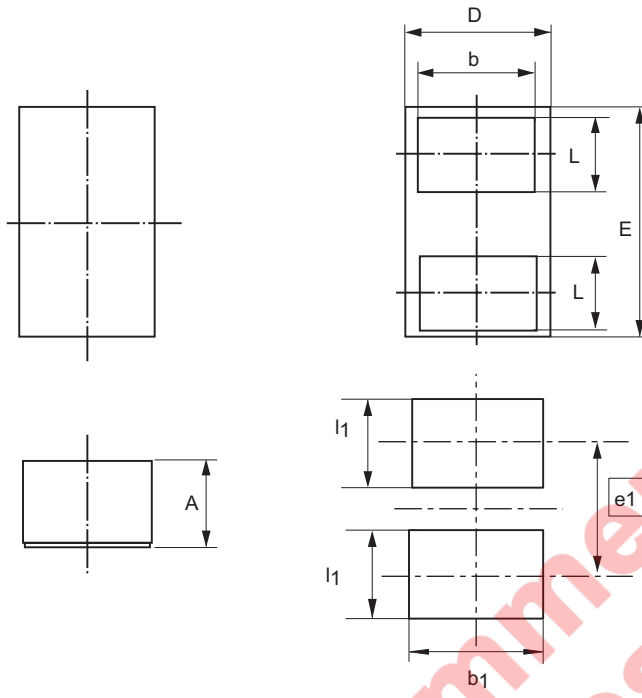


Fig.4 Forward resistance vs. Forward current

Package Dimensions

Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
MP8	—	PXSN0002ZA-A	MP8V	0.00029g

Under development



Pattern of terminal position areas

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
A	0.27	0.30	0.33
b	0.38	0.40	0.42
D	0.47	0.50	0.53
E	0.77	0.80	0.83
L	0.23	0.25	0.27
b1	—	0.45	—
e1	—	0.45	—
l1	—	0.3	—

Not recommended for new design

Keep safety first in your circuit designs!

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